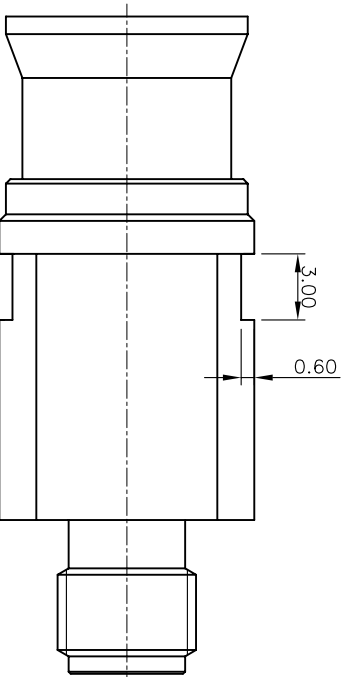
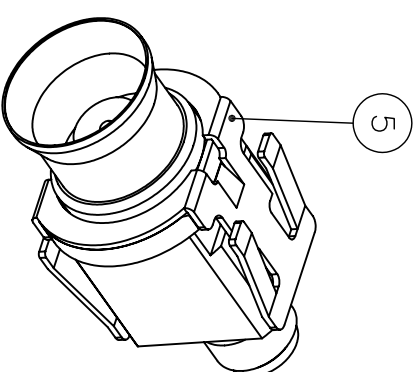
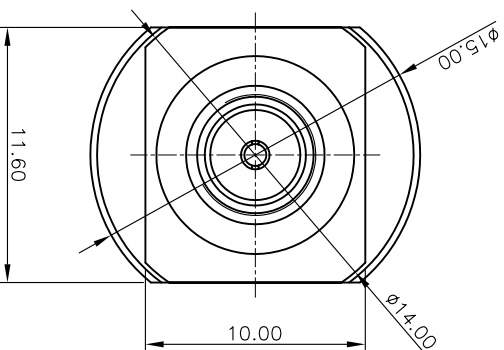
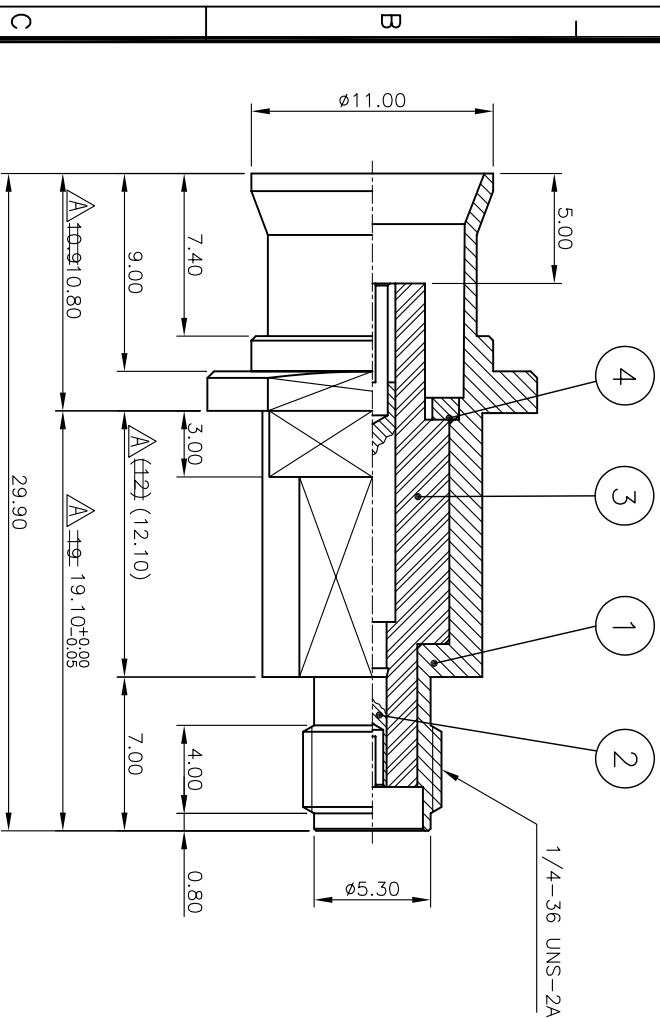


REVISION		
REV	DESCRIPTION	DATE
1/R	최초 개칭	2006. 8. 8.
A	신뢰성 향상[열변No.연구2007-150] (BODY와 프레임품 조합 시 빠짐 방지)	2007. 10. 1.



NO.	DESCRIPTION	QTY	MATERIAL	PLATING	CODE
3	LOCK PANEL	1	SUS	Nickel Plate	DSR00071-N/1 (XE057)
2	INSERT	1	MBsBD	Nickel Plate	DSR00051-5/1 (L7009)
3	INSULATOR	1	TEFLON	White	DAI00046-N/1 (HA221)
2	CONTACT	1	BeCu	Gold Plate	DAC00075-5/1 (EA254)
1	BODY	1	MBsBD	Nickel Plate	DAD00085-5/1 (DA292)

TOLERANCE	Decimal	±0.1
	Angle	±1°
MATERIAL	CHECKED BY	I.C.KIM
	DRAWN BY	E.H.KIM
FINISH	SCALE	8/1
DATE		2006. 8. 8
APPROVED BY		S.J.YOUN
TITLE		SMA50J-H4-TRU50J
DWG NO.		AD00164-7/1(K361-521-000)
REVISION		1 R
SHEET		1 of 1



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